**Inverting Schmitt trigger** 

Rev. 1 — 13 July 2012

**Product data sheet** 

## 1. General description

74AHC1G14-Q100 and 74AHCT1G14-Q100 are high-speed Si-gate CMOS devices. They provide an inverting buffer function with Schmitt-trigger action. These devices can transform slowly changing input signals into sharply defined, jitter-free output signals.

The AHC device has CMOS input switching levels and supply voltage range 2 V to 5.5 V.

The AHCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
   Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- SOT353-1 and SOT753 package options

## 3. Applications

- Wave and pulse shapers
- Astable multivibrators
- Monostable multivibrators



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## 4. Ordering information

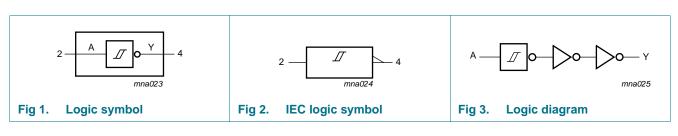
Table 1. Ordering information								
Type number	Package							
	Temperature range	Name	Description	Version				
74AHC1G14GW-Q100	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads;	SOT353-1				
74AHCT1G14GW-Q100			body width 1.25 mm					
74AHC1G14GV-Q100	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753				
74AHCT1G14GV-Q100								

## 5. Marking

Type numberMarking code[1]74AHC1G14GW-Q100AF74AHC10140W 010005	
74AHCT1G14GW-Q100 CF	
74AHC1G14GV-Q100 A14	
74AHCT1G14GV-Q100 C14	

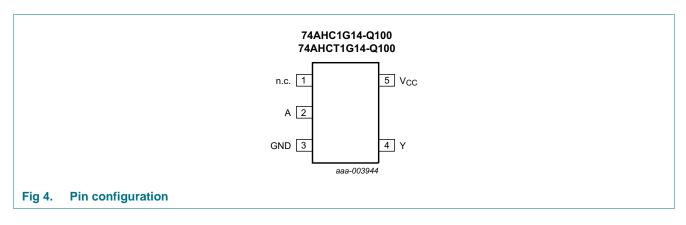
[1] The pin 1 indicator is on the lower left corner of the device, below the marking code.

## 6. Functional diagram



## 7. Pinning information

## 7.1 Pinning



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## 7.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
n.c.	1	not connected
А	2	data input
GND	3	ground (0 V)
Y	4	data output
V <sub>CC</sub>	5	supply voltage

## 8. Functional description

#### Table 4.Function table

*H* = *HIGH* voltage level; *L* = *LOW* voltage level

Input	Output
Α	Y
L	Н
Н	L

## 9. Limiting values

#### Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < -0.5 V	-20	-	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I <sub>CC</sub>	supply current		-	75	mA
I <sub>GND</sub>	ground current		-75	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2] _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For both TSSOP5 and SC-74A packages: above 87.5 °C the value of P<sub>tot</sub> derates linearly with 4.0 mW/K.

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## 10. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	74AH0	C1G14-Q	100	74AHCT1G14-Q100			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C

## **11. Static characteristics**

#### Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol Parameter		Conditions		25 °C		–40 °C	to +85 °C	–40 °C	to +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC1G14-Q	100	•				1			•
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{T+} \text{ or } V_{T-}$								
	output voltage	$I_{O}$ = -50 $\mu$ A; $V_{CC}$ = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
	$I_{O} = -50 \ \mu A; \ V_{CC} = 3.0 \ V$	2.9	3.0	-	2.9	-	2.9	-	V	
		$I_{O} = -50 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub> LOW-level		$V_{I} = V_{T+} \text{ or } V_{T-}$								
	output voltage	$I_0 = 50 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 3.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_{O} = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μA
I <sub>CC</sub>	supply current		-	-	1.0	-	10	-	40	μA
CI	input capacitance		-	1.5	10	-	10	-	10	pF
For type	74AHCT1G14-	Q100								
V <sub>он</sub>	HIGH-level	$V_{I} = V_{T+} \text{ or } V_{T-}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -8.0 mA	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{T+}$ or $V_{T-}$ ; $V_{CC} = 4.5 V$								
	output voltage	I <sub>O</sub> = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		l <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
lı	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
74AHC_AHCT10	G14 Q100	All information provided	in this docum	nent is subje	ct to legal dis	claimers.		© N	XP B.V. 2012. All rig	hts reserv

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## Table 7.Static characteristics ... continuedVoltages are referenced to GND (ground = 0 V).

Symbol Parameter	Parameter	Conditions		25 °C		–40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
		Min	Тур	Max	Min	Max	Min	Max		
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	1.0	-	10	-	40	μA
$\Delta I_{CC}$	additional supply current	per input pin; V <sub>I</sub> = 3.4 V; other inputs at V <sub>CC</sub> or GND; $I_O = 0 A$ ; V <sub>CC</sub> = 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance		-	1.5	10	-	10	-	10	pF

### **11.1 Transfer characteristics**

#### Table 8. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). See Figure 7 and Figure 8.

Symbol	Parameter	Conditions		25 °C	10	–40 °C	to +85 °C	–40 °C	to +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
For type	<b>74AHC1G14-Q</b> 1	00								
V <sub>T+</sub>	V <sub>T+</sub> positive-going threshold voltage	$V_{CC} = 3.0 V$	-	-	2.2	-	2.2	-	2.2	V
		$V_{CC} = 4.5 V$	-	-	3.15	-	3.15	-	3.15	V
	vollage	$V_{CC} = 5.5 V$	-	-	3.85	-	3.85	-	3.85	V
V <sub>T-</sub> negative-going	$V_{CC} = 3.0 V$	0.9	-	-	0.9	-	0.9	-	V	
	threshold voltage	$V_{CC} = 4.5 V$	1.35	-	-	1.35	-	1.35	-	V
	voltage	$V_{CC} = 5.5 V$	1.65	-	-	1.65	-	1.65	-	V
V <sub>H</sub>	V <sub>H</sub> hysteresis	$V_{CC} = 3.0 V$	0.3	-	1.2	0.3	1.2	0.25	1.2	V
	voltage	$V_{CC} = 4.5 V$	0.4	-	1.4	0.4	1.4	0.35	1.4	V
		$V_{CC} = 5.5 V$	0.5	-	1.6	0.5	1.6	0.45	1.6	V
For type	• 74AHCT1G14-0	2100								
$V_{T+}$	positive-going	$V_{CC} = 4.5 V$	-	-	2.0	-	2.0	-	2.0	V
	threshold voltage	$V_{CC} = 5.5 V$	-	-	2.0	-	2.0	-	2.0	V
V <sub>T-</sub>	negative-going	$V_{CC} = 4.5 V$	0.5	-	-	0.5	-	0.5	-	V
	threshold voltage	$V_{CC} = 5.5 V$	0.6	-	-	0.6	-	0.6	-	V
V <sub>H</sub>	hysteresis	$V_{CC} = 4.5 V$	0.4	-	1.4	0.4	1.4	0.35	1.4	V
	voltage	V <sub>CC</sub> = 5.5 V	0.4	-	1.6	0.4	1.6	0.35	1.6	V

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## **12. Dynamic characteristics**

#### Table 9. Dynamic characteristics

GND = 0 V;  $t_r = t_f \le 3.0$  ns. For waveform see <u>Figure 5</u>. For test circuit see <u>Figure 6</u>.

Symbol	Parameter	Conditions			25 °C		–40 °C	to +85 °C	–40 °C	to +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC1G14	-Q100									
t <sub>pd</sub>	propagation	A to Y;	<u>[1]</u>								
delay	delay	$V_{CC}$ = 3.0 V to 3.6 V	[2]								
		C <sub>L</sub> = 15 pF		-	4.2	12.8	1.0	15.0	1.0	16.5	ns
		C <sub>L</sub> = 50 pF		-	6.0	16.3	1.0	18.5	1.0	20.5	ns
		$V_{CC}$ = 4.5 V to 5.5 V	[3]								
		C <sub>L</sub> = 15 pF		-	3.2	8.6	1.0	10.0	1.0	11.0	ns
		C <sub>L</sub> = 50 pF		-	4.6	10.6	1.0	12.0	1.0	13.5	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}$ ; f = 1 MHz; $V_I = \text{GND}$ to $V_{CC}$	[4]	-	12	-	-	-	-	-	pF
For type	74AHCT1G1	4-Q100									
t <sub>pd</sub>	propagation delay	A to Y; V <sub>CC</sub> = 4.5 V to 5.5 V	<u>[1]</u> [3]								
		C <sub>L</sub> = 15 pF		-	4.1	7.0	1.0	8.0	1.0	9.0	ns
		C <sub>L</sub> = 50 pF		-	5.9	8.5	1.0	10.0	1.0	11.0	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $V_I = GND$ to $V_{CC}$	[4]	-	13	-	-	-	-	-	рF

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[2] Typical values are measured at  $V_{CC}$  = 3.3 V.

[3] Typical values are measured at  $V_{CC}$  = 5.0 V.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation P<sub>D</sub> ( $\mu$ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

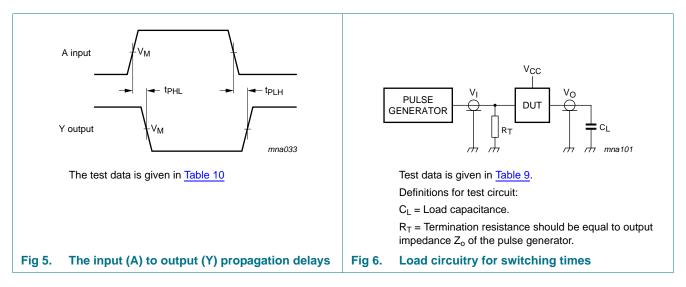
 $f_o$  = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts.

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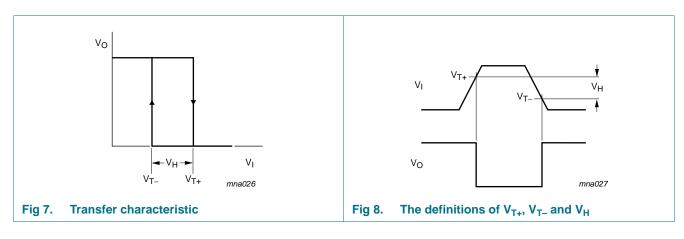
## 13. Waveforms



#### Table 10. Test data

Type number	Input	Input C			
	VI	V <sub>M</sub>	V <sub>M</sub>		
74AHC1G14-Q100	GND to V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$		
74AHCT1G14-Q100	GND to 3.0 V	1.5 V	$0.5  imes V_{CC}$		

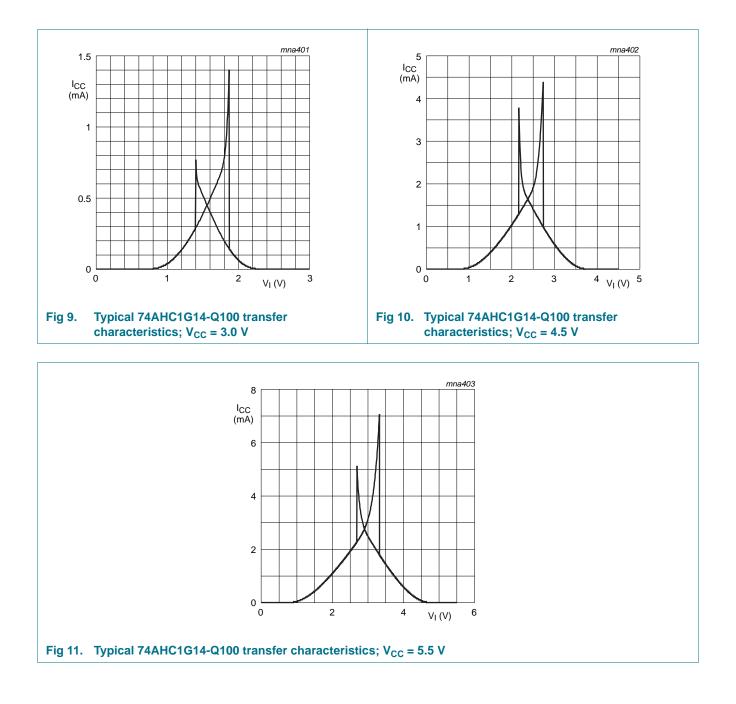
### **13.1 Transfer characteristic waveforms**



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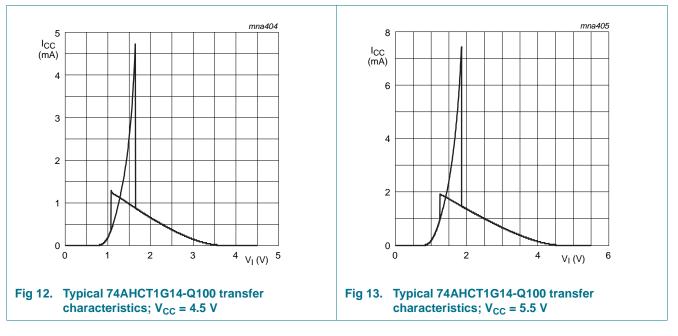
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## 14. Application information

The slow input rise and fall times cause additional power dissipation, which can be calculated using the following formula:

 $P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC}$  where:

 $P_{add}$  = additional power dissipation ( $\mu$ W);

- f<sub>i</sub> = input frequency (MHz);
- $t_r$  = input rise time (ns); 10 % to 90 %;
- $t_f$  = input fall time (ns); 90 % to 10 %;

 $\Delta I_{CC(AV)}$  = average additional supply current (µA).

Average additional  $I_{CC}$  differs with positive or negative input transitions, as shown in Figure 14 and Figure 15.

For 74AHC1G14-Q100 and 74AHCT1G14-Q100 used in relaxation oscillator circuit, see Figure 16.

#### Note to the application information:

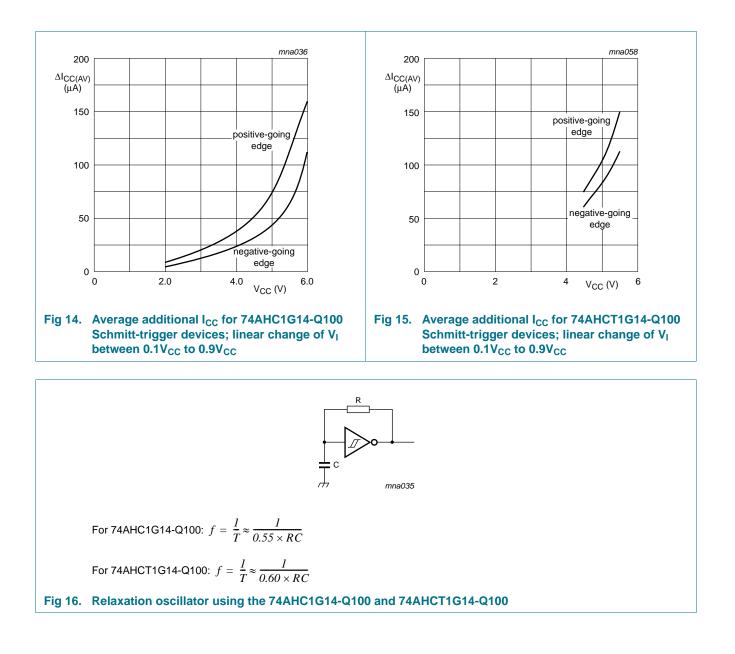
1. All values given are typical unless otherwise specified.

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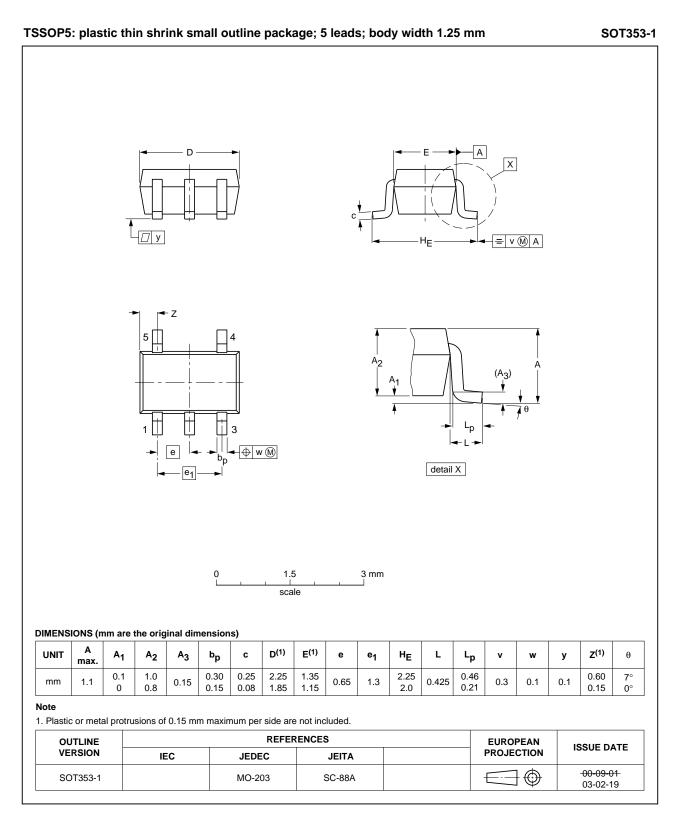
# 74AHC1G14-Q100; 74AHCT1G14-Q100

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## 15. Package outline

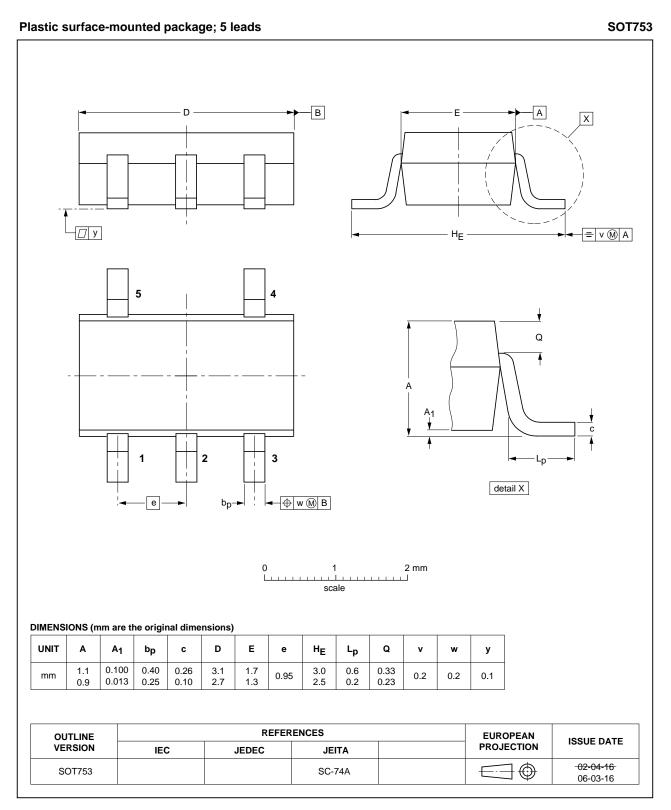


#### Fig 17. Package outline SOT353-1 (TSSOP5)

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#### Fig 18. Package outline SOT753 (SC-74A)

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## **16. Abbreviations**

Table 11.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic
MIL	Military

## 17. Revision history

Table 12.         Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT1G14_Q100 v.1	20120713	Product data sheet	-	-

## **18. Legal information**

### 18.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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